## **General Description**

**Applications** 

The MAX14523A/MAX14523AL/MAX14523B/MAX14523C programmable current-limit switches feature internal current limiting to prevent damage to host devices due to faulty load conditions. These current-limit switches feature a low 70m $\Omega$  on-resistance and operate from a +1.7V to +5.5V input voltage range. The current limit is adjustable from 250mA to 1.5A, making these devices ideal for SDIO (secure digital input/output) and other load-switching applications.

Each device in the family handles an overcurrent event differently depending on the option selected. The MAX14523A/MAX14523AL go into an autoretry mode, the MAX14523B latches off the switch, and the MAX14523C features a continuous current-limit mode. Additional safety features include thermal shutdown to prevent overheating and reverse-current blocking to prevent current from being driven back into the source.

The MAX14523A/MAX14523AL/MAX14523B/MAX14523C are available in a tiny 8-pin, 3mm x 3mm, TDFN package and operate over the -40°C to +125°C automotive temperature range.

SDIO Ports USB Ports Notebook VGA Ports GPS Cell Phones MP3 Players UTCA/ATCA Platforms

### Pin Configuration appears at end of data sheet.

## \_\_\_\_ Features

- Accurate (±10%) Overload Current Limit
- Adjustable Current-Limit Threshold
- Low-Dropout Voltage (70mV at 1A Load Current)
- Short-Circuit Protection
- Thermal-Shutdown Protection
- Reverse-Current Protection
- 170µA (typ) Supply Current
- Shutdown Reverse Current, 0.6µA (max)
- +1.7V to +5.5V Supply Voltage Range
- Tiny 8-Pin, 3mm x 3mm, TDFN Package

### **Typical Operating Circuit**

### BIAS VOLTAGE LOAD POWER SUPPLY 1♦[ 1uE -CHARGE PUMP иF CURRENT CONTROL NC *м*лхі*м* MAX14523 MAX14523AL MAX14523B MAX14523C Ŧ \*ON FOR THE MAX14523AL ONLY.

# **Ordering Information/Selector Guide**

PART	PIN-PACKAGE	TOP MARK	ON POLARTIY	OVERCURRENT RESPONSE
MAX14523AATA+	8 TDFN-EP*	BLO	Active-High	Autoretry
MAX14523ALATA+**	8 TDFN-EP*	BLP	Active-Low	Autoretry
MAX14523BATA+	8 TDFN-EP*	BLQ	Active-High	Latch-Off
MAX14523CATA+	8 TDFN-EP*	BLS	Active-High	Continuous

Note: All devices are specified over the -40°C to +125°C operating temperature range.

+Denotes a lead(Pb)-free package/RoHs-compliant package.

\*EP = Exposed pad.

\*\*Future product—contact factory for availability.

### 

\_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

(All voltages referenced to GND.)

(All voltages referenced to GIND.)
IN, ON, ON, FLAG, OUT, and SETI to GND0.3V to +6V
Current into Any Pin (Except IN, OUT)20mA
Out Short Circuit to GNDInternally Limited
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ ) for multilayer board:
8-Pin TDFN (derate 24.4mW/°C above +70°C)1952mW
Junction-to-Case Thermal Resistance ( $\theta_{JC}$ )
(Note 1)8.0°C/W

Junction-to-Ambient Thermal Resistance	$(\theta_{JA})$
(Note 1)	41.0°C/W
Operating Temperature Range	40°C to +125°C
Junction Temperature	+150°C
Storage Temperature Range	
Lead Temperature (soldering, 10s)	+300°C

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a fourlayer board. For detailed information on package thermal considerations, refer to <u>www.maxim-ic.com/thermal-turorial</u>.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = +1.7V \text{ to } +5.5V, R_{SETI} = 94.2k\Omega, C_{IN} = C_{OUT} = 1\mu\text{F}$ , and  $T_A = T_J = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $V_{IN} = +3.3V$ ,  $T_A = +25^{\circ}\text{C}$ .) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	МАХ	UNITS
SUPPLY OPERATION						
Operating Voltage	VIN		1.7		5.5	V
Quiescent Current	lq	$I_{OUT} = 0A$ , switch on, $V_{IN} = 3.3V$		170	300	μΑ
Latchoff Current	ILATCH	$V_{\text{IN}}$ = 3.3V, $I_{\text{OUT}}$ = 0A , after an overcurrent fault (MAX14523B)		10	20	μA
Shutdown Forward Current	ISHDN	$V_{ON} = 0V, V_{\overline{ON}} = V_{IN}, V_{IN} = 5.5V, V_{OUT} = 0V$		0.5	7	μΑ
Shutdown Reverse Current	IRSHDN	$V_{ON} = 0V, V_{\overline{ON}} = V_{IN}, V_{IN} = 1.7V, V_{OUT} = 5.5V (current into OUT)$		0.01	0.6	μA
INTERNAL FET						
Switch-On Resistance	Ron	$V_{IN}$ = 3.3V, $I_{OUT}$ lower than $I_{LIM}$		70	130	mΩ
Forward-Current Limit	luna	$R_{SETI} = 91.78 k\Omega$ , $V_{IN} - V_{OUT} = 1V$	1350	1500	1650	- mA
	ILIM	$R_{SETI} = 563.12 k\Omega$ , $V_{IN} - V_{OUT} = 1V$	225	250	275	
$(R_{SETI} + 2.48 \text{k}\Omega) \times I_{LIM} \text{ Product}$		I <sub>LIM</sub> = 250mA to 1500mA, V <sub>IN</sub> - V <sub>OUT</sub> = 1V	127.2	141.4	155.5	kV
Reverse Blocking Current		V <sub>OUT</sub> > V <sub>IN</sub> + 140mV, after reverse-current- limit shutdown			2	μA
Reverse Blocking Threshold	Vout - Vin	$V_{OUT}$ - $V_{IN}$ = 300mV, OUT falling until switch turns on	40	95	140	mV
FLAG Assertion Drop Voltage Threshold	VFA	Increase (V <sub>IN</sub> - V <sub>OUT</sub> ) drop until $\overline{FLAG}$ asserts, I <sub>OUT</sub> limiting, V <sub>IN</sub> = 3.3V		350		mV
ON, ON INPUT		•				
ON, ON Input Leakage	ILEAK	$V_{ON}, V_{\overline{ON}} = V_{IN} \text{ or } V_{GND}$	-1		+1	μA
ON, ON Input Logic-High Voltage	VIH		1.6			V
ON, ON Input Logic-Low Voltage	VIL				0.4	V

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = +1.7V \text{ to } +5.5V, R_{SETI} = 94.2k\Omega, C_{IN} = C_{OUT} = 1\mu\text{F}$ , and  $T_A = T_J = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ , unless otherwise noted. Typical values are at  $V_{IN} = +3.3V$ ,  $T_A = +25^{\circ}\text{C}$ .) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
FLAG OUTPUT		•	•			
FLAG Output Logic-Low Voltage		I <sub>SINK</sub> = 1mA			0.4	V
FLAG Output Leakage Current		$V_{IN} = V_{FLAG} = 5.5V, FLAG$ deasserted			1	μA
DYNAMIC						
Turn-On Time	tss	Time from ENABLE signal to $V_{OUT} = 90\%$ of $V_{IN} = 3.3V$ , Figure 1		1		ms
Turn-Off Time	tOFF	Time from DISABLE signal to $V_{OUT}$ = 10% of $V_{IN}$ = 3.3V, $R_L$ = 20 $\Omega$ , Figure 1		250		μs
Current-Limit Reaction Time	tLIM	$V_{IN} = 3.3V$ , $R_{SETI} = 91.78k\Omega$ to $563.12k\Omega$ , output high and then short-circuit applied		3		μs
Blanking Time	<b>t</b> BLANK	(Note 3)	10	14.5	25	ms
Retry Time	<b>t</b> RETRY	MAX14523A/MAX14523AL (Note 3)	320		875	ms
THERMAL PROTECTION						
Thermal Shutdown		Low-to-high		+170		°C
Thermal Shutdown Hysteresis				15		°C

Note 2: All devices are 100% tested at 125°C. Electrical limits across the full temperature range are guaranteed by design and correlation.

**Note 3:** Blanking time and retry time are generated by the same oscillator. Therefore, the ratio of  $\frac{t_{\text{RETRY}}}{t_{\text{BLANK}}}$  is a constant value of 32.

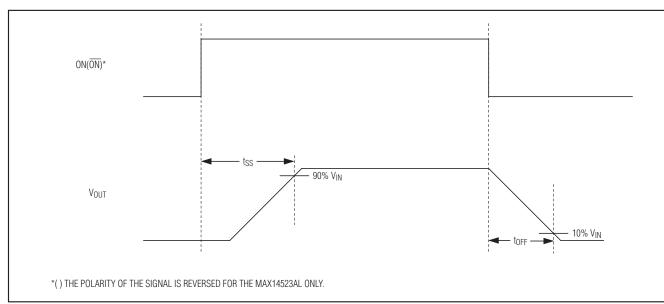
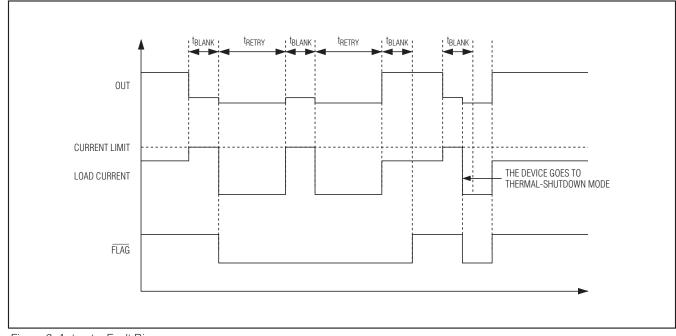
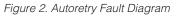


Figure 1. Timing Diagram for Measuring Turn-On Time (t<sub>SS</sub>) and Turn-Off Time (t<sub>OFF</sub>)





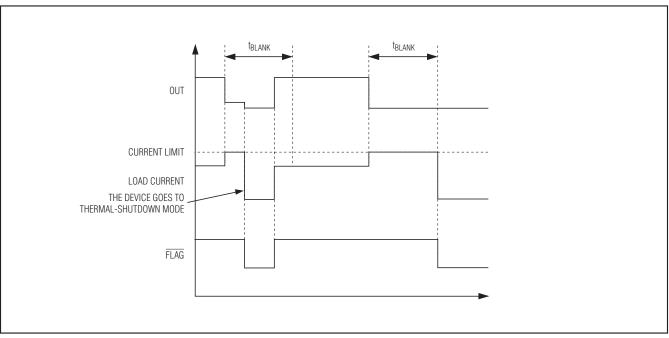
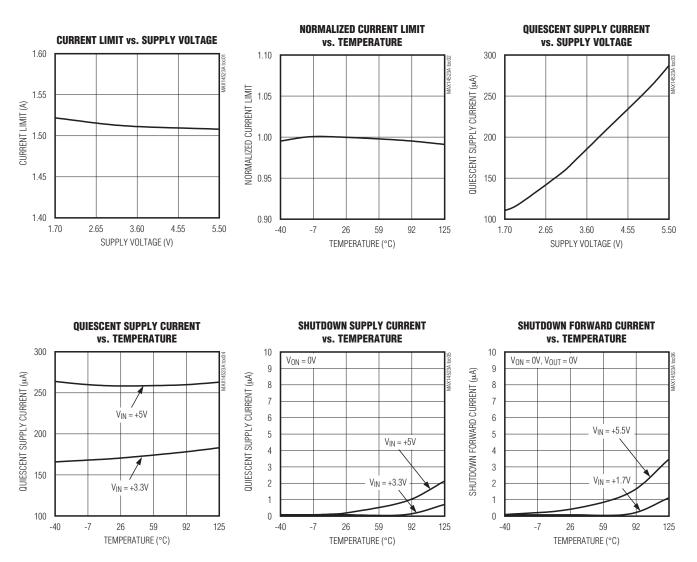


Figure 3. Latchoff Fault Diagram

### **Typical Operating Characteristics**

(V<sub>IN</sub> = +3.3V, C<sub>IN</sub> = 1 $\mu$ F, C<sub>OUT</sub> = 1 $\mu$ F, R<sub>SETI</sub> = 94.2k $\Omega$ , T<sub>A</sub> = +25°C, unless otherwise noted.)

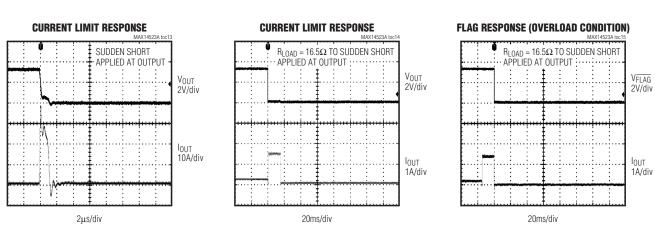


### (V<sub>IN</sub> = +3.3V, C<sub>IN</sub> = 1 $\mu$ F, C<sub>OUT</sub> = 1 $\mu$ F, R<sub>SETI</sub> = 94.2k $\Omega$ , T<sub>A</sub> = +25°C, unless otherwise noted.) SHUTDOWN REVERSE CURRENT LATCHOFF CURRENT NORMALIZED ON-RESISTANCE vs. TEMPERATURE vs. TEMPERATURE vs. SUPPLY VOLTAGE 10 30 1.20 $V_{ON} = 0V, V_{IN} = +1.7V, V_{OUT} = +5.5V$ MAX14523B 9 SHUTDOWN REVERSE CURRENT (MA) 1.15 25 8 **VORMALIZED ON-RESISTANCE** 1.10 LATCHOFF CURRENT (µA) $V_{IN} = +5.5V$ 7 20 1.05 6 5 15 1.00 4 0.95 10 3 0.90 2 5 0.85 $V_{IN} = +3.3V$ 1 0 0 0.80 -40 -40 -7 26 59 92 125 1.70 2.65 3.60 4.55 5.50 -7 26 59 92 125 TEMPERATURE (°C) TEMPERATURE (°C) VOLTAGE (V) NORMALIZED ON-RESISTANCE **SWITCH TURN-ON TIME SWITCH TURN-OFF TIME** vs. SUPPLY TEMPERATURE **vs. SUPPLY TEMPERATURE** vs. SUPPLY TEMPERATURE 1.5 1.5 1000 $R_{LOAD} = 20\Omega$ $R_{LOAD} = 20\Omega$ 1.4 1.4 900 V<sub>IN</sub> = +5.0V 1.3 1.3 800 SWITCH TURN-OFF TIME (µs) NORMALIZED ON-RESISTANCE SWITCH TURN-ON TIME (ms) 1.2 1.2 700 1.1 1.1 600 1.0 500 1.0 $V_{IN} = +5.0V$ 0.9 0.9 400 V<sub>IN</sub> = +3.3V 0.8 300 0.8 0.7 0.7 200 0.6 0.6 100 V<sub>IN</sub> = +3.3V 0.5 0.5 0 -40 -7 -7 -40 -7 26 59 92 -40 26 59 92 26 59 92 125 125 125 TEMPERATURE (°C) TEMPERATURE (°C) TEMPERATURE (°C)

**Typical Operating Characteristics (continued)** 

### Typical Operating Characteristics (continued)

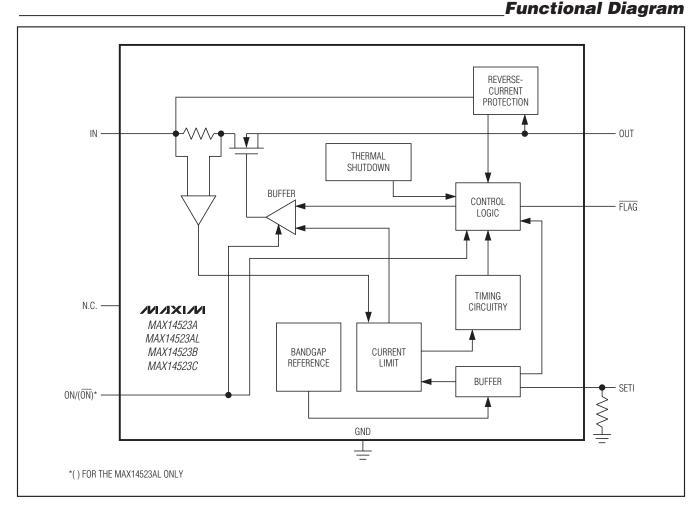
(V<sub>IN</sub> = +3.3V, C<sub>IN</sub> = 1 $\mu$ F, C<sub>OUT</sub> = 1 $\mu$ F, R<sub>SETI</sub> = 94.2k $\Omega$ , T<sub>A</sub> = +25°C, unless otherwise noted.)



### \_Pin Description

P	PIN			
MAX14523AL	MAX14523A MAX14523B MAX14523C	NAME	FUNCTION	
1, 6	1, 6	N.C.	No Connection. Not internally connected. Connect N.C. to GND or leave unconnected.	
2	2	FLAG	Open-Drain, Overload Indicator Output. FLAG goes low when the overload fault duration exceeds the blanking time, reverse current is detected, thermal shutdowr mode is active, or SETI is connected to ground.	
3	3	SETI	Overload-Current Limit Adjust. Connect a resistor from SETI to GND to program th overcurrent limit. If SETI is connected to GND the switch turns off and FLAG is asserted. If SETI is unconnected the current limit is at 0mA. Do not connect any capacitance larger than 20pF to SETI.	
4	4	OUT	Switch Output. Bypass OUT with a 1µF capacitor to GND.	
5	5	IN	Power Input. Bypass IN with a 1µF ceramic capacitor to GND. Use higher capacitance if necessary to prevent large load transients from pulling down the supply voltage.	
7	—	ŌN	Active-Low, Switch-ON Input. Drive ON low to turn on the switch.	
	7	ON	Active-High, Switch-ON Input. Drive ON high to turn on the switch.	
8	8	GND	Ground	
_	_	EP	Exposed Pad. Internally connected to GND. For enhanced thermal dissipation, connect EP to a large copper ground plane. Do not use EP as the sole ground connection.	

# MAX14523A/MAX14523AL/MAX14523B/MAX14523C



### **Detailed Description**

The MAX14523A/MAX14523AL/MAX14523B/MAX14523C programmable current-limit switches operate from +1.7V to +5.5V and provide internal current limiting adjustable from 250mA to 1.5A. These devices feature a fixed blanking time, and a FLAG output that notifies the processor when a fault condition is present.

**Programmable Current Limit/Threshold** A resistor from SETI to GND sets the current limit/threshold for the switch (see the *Setting the Current Limit/Threshold* section). If the output current is limited at the current threshold value for a time equal to or longer than t<sub>BLANK</sub>, the output flag asserts and the MAX14523A/MAX14523AL enter the autoretry mode, the MAX14523B latches off the switch, and the MAX14523C enters the continuous current-limit mode.

### Autoretry (MAX14523A/MAX14523AL)

When the forward current reaches the current threshold, the tBLANK timer begins counting (Figure 2). FLAG asserts if the overcurrent condition is present for tBLANK or longer. The timer resets if the overcurrent condition disappears before the blanking time (tBLANK) has elapsed. A retry time delay (tRETRY) starts immediately after the blanking time has elapsed. During that time, the switch latches off. At the end of tRETRY, the switch turns on again. If the fault still exists, the cycle repeats. If the fault has been removed, the switch stays on. During this cycle, FLAG stays low. In autoretry, if the die temperature exceeds +170°C (typ) due to self heating, the MAX14523A/MAX14523AL go into thermal shutdown until the die temperature drops by approximately 15°C (see the *Thermal Shutdown* section.)



The autoretry feature saves system power in case of an overcurrent or short-circuit condition. During  $t_{BLANK}$  time, when the switch is on, the supply current is held at the current limit. During time  $t_{RETRY}$ , when the switch is off, the current through the switch is zero. Thus, the average output current is much less than the programmed current limit. Calculate the average output current using the following equation:

 $I_{LOAD} = I_{LIM} [(t_{BLANK})/(t_{BLANK} + t_{RETRY})]$ 

With a typical  $t_{BLANK} = 17.5$ ms and typical  $t_{RETRY} = 560$ ms, the duty cycle is 3%, resulting in a 97% power savings over the switch being on the entire time.

### Latchoff (MAX14523B)

When the forward current reaches the current threshold, the  $t_{BLANK}$  timer begins counting (Figure 3). FLAG asserts if an overcurrent condition is present for greater than  $t_{BLANK}$  time. The timer resets if the overcurrent condition disappears before  $t_{BLANK}$  has elapsed. The switch turns off if the overcurrent condition continues beyond the blanking time. Reset the switch by either toggling the control logic (ON or  $\overline{ON}$ ) or cycling the input voltage. If the die temperature exceeds +170°C (typ) due to self heating, the MAX14523B goes into thermal shutdown until the die temperature drops by approximately 15°C (see the *Thermal Shutdown* section).

### **Continuous Current Limit (MAX14523C)**

When the forward current reaches the forward-current threshold, the MAX14523C limits the output current to the programmed current limit. FLAG asserts if the current limit is present for t<sub>BLANK</sub> and deasserts when the overload condition is removed. In this mode, if die temperature exceeds +170°C (typ) due to self heating, the MAX14523C goes into thermal shutdown until the die temperature drops by approximately 15°C (see the *Thermal Shutdown* section).

### Table 1. Switch Truth Table

MAX14523A MAX14523B MAX14523C	MAX14523AL	SWITCH STATUS
ON	ŌN	
0	1	Off
1	0	On

### Switch-On/Off Control

The ON input for the MAX14523A/MAX14523B/ MAX14523C and ON input for the MAX14523AL control the switch, see Table 1. Toggle ON for the MAX14523B to reset the fault condition once the short-circuit current is detected and the device shuts down.

### **Reverse-Current Protection**

The MAX14523A/MAX14523AL/MAX14523B/MAX14523C feature a reverse-current protection circuit that limits the backflow current to 2µA when the reverse-current protection circuitry has tripped. The switch turns off and FLAG asserts without waiting for tBLANK to elapse. The switch turns back on and FLAG deasserts when V<sub>IN</sub> - V<sub>OUT</sub> drops below the reverse-current threshold by 95mV (typ).

### **FLAG Indicator**

FLAG is an open-drain fault indicator output and requires an external pullup resistor to a DC supply. FLAG goes low when any of the following conditions occur:

- The blanking time has elapsed
- The reverse-current protection has tripped
- The die temperature exceeds +170°C
- SETI is connected to ground.

### **Thermal Shutdown**

Thermal-shutdown circuitry protects the devices from overheating. The switch turns off and FLAG goes low immediately when the junction temperature exceeds +170°C (typ). The switch turns on again after the device temperature drops by approximately 15°C (typ).

### **Applications Information**

### **Setting the Current Limit/Threshold**

A resistor from SETI to ground programs the current limit/threshold value for the MAX14523A/MAX14523AL/ MAX14523B/MAX14523C. Table 2 lists various current limit/thresholds set by different resistor values at SETI. Leaving SETI unconnected selects a 0 current limit/threshold. Connecting SETI to ground asserts FLAG.

Use the following formula to calculate the current limit:

$$\mathsf{R}_{\text{SETI}}(k\Omega) = \frac{141400(V)}{\mathsf{I}_{\text{LIM}}(\text{mA})} - 2.48(k\Omega)$$

### Table 2. Current Limit/Threshold vs. **Resistor Values**

<b>R</b> SETI ( <b>k</b> Ω)	TYPICAL CURRENT LIMIT/THRESHOLD (mA)
91.78	1500
121	1145
221	632
301	466
422	333
563.12	250
∞ (Open)	0

Do not use an R<sub>SETI</sub> value smaller than  $91.78k\Omega$ .

Note: Connecting any capacitance larger than 20pF to SETI can cause instability.

### **IN Bypass Capacitor**

Connect a minimum of 1µF capacitor from IN to GND to limit the input voltage drop during momentary output short-circuit conditions. Larger capacitor values further reduce the voltage undershoot at the input.

### **OUT Bypass Capacitor**

For stable operation over the full temperature range and over the full-programmable current-limit range, use a 1µF ceramic capacitor from OUT to ground.

Excessive output capacitance can cause a false overcurrent condition due to decreased dv/dt across the capacitor. Calculate the maximum capacitive load (CMAX) value that can be connected to OUT using the following formula:

$$C_{MAX}(\mu F) = \frac{I_{LIM}(mA) \times t_{BLANK(MIN)}(ms)}{V_{IN}(V)}$$

For example, for  $V_{IN} = 3.3V$ ,  $t_{BLANK} = 10$ ms, and  $I_{LIM} =$ 300mA, CMAX equals 909µF.

### **Layout and Thermal Dissipation**

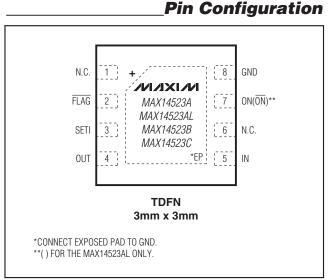
To optimize the switch response time to output shortcircuit conditions, it is very important to keep all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place input and output capacitors as close as possible to the device (no more than 5mm). IN and OUT must be connected with wide short traces to the power bus. During normal operation, the power dissipation is small and the package temperature change is minimal. If the output is continuously shorted to ground at the maximum supply voltage, the operation of the switches with the autoretry option does not cause problems because the total power dissipated during the short is scaled by the duty cycle:

$$P_{(MAX)} = \frac{V_{IN(MAX)} \times I_{OUT(MAX)} \times t_{BLANK}}{t_{RETRY} + t_{BLANK}}$$

Attention must be given to the MAX14523C continuous current-limit version when the power dissipation during a fault condition can cause the device to reach the thermal shutdown threshold.

### Chip Information

PROCESS: BICMOS



### **Package Information**

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
8 TDFN-EP	T833+2	<u>21-0137</u>

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

MAX14523A/MAX14523AL/MAX14523B/MAX14523C

Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600

© 2009 Maxim Integrated Products

Maxim is a registered trademark of Maxim Integrated Products, Inc.